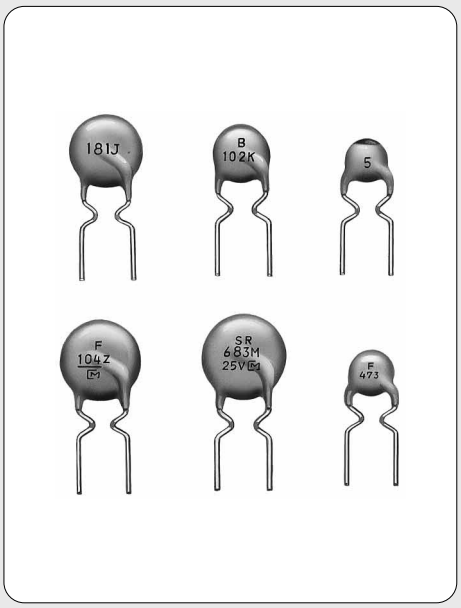
CERAMIC CAPACITOR 12V/16V/25V/50V/500V

DD100·DD10·DD300·DD400 Series

CERAMIC CAPACITOR



muRata Innovator in Electronics

Murata
Manufacturing Co., Ltd.

Cat. No. C83E-2

■ CONTENT

■ PRECAUTION

1. Operating voltage
Be sure to use a capacitor only within its rated operating voltage range. When DC-rated capacitors are to be used in AC or ripple voltage circuits, be sure to maintain the Vp-p value of the applied voltage within the rated voltage range.

2. Operating temperature and self-generated heat
Keep the surface temperature of a capacitor within the rated operating temperature range. Be sure to take into account the heat produced by the capacitor itself. When a capacitor is used in a high-frequency circuit, pulse voltage circuit or the like, it may produce heat due to dielectric loss. Keep such self-generated temperature below 20˚C.

3. Operating and storage environment
The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present and avoid exposure to moisture. Before cleaning, bonding, or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment.
Store the capacitors where the temperature and relative humidity do not exceed 5 to 40˚C and 20 to 70% RH. Use capacitors within 6 months.

4. Vibration and impact
Do not expose a capacitor or its leads to excessive shock or vibration during use.

Failure to follow the above cautions may result, worst case, in a short circuit and fuming when the product is used.

■ NOTICE

Soldering
When soldering this product to a PC board, do not exceed the solder heat resistance specification (written in 6. specification and test method) of the capacitor. Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.

■ ISO9000 CERTIFICATIONS

Manufacturing plants of these products in this catalog have obtained the ISO9000 quality system certificate.

Plant	Certified Date	Organization	Registration No.	Applied standard
Iwami Murata Manufacturing Co., Ltd.	Jul. 29. '92	*RCJ	RCJ-85M-02B	ISO 9002
Izumo Murata Manufacturing Co., Ltd.	May. 11. '95	*RCJ	RCJ-93M-05A	ISO 9001
Murata Electronics (Thailand) , Ltd.	Jul. 29. '92	*RCJ	RCJ (T) -91M-02A	ISO 9002

*RCJ: Reliability Center for Electronic Components of Japan

■ GENERAL DESCRIPTION OF CERAMIC CAPACITORS

Ceramic capacitors are produced by sandwiching a ceramic-dielectric layer of titanium oxide (TiO_2)or barium titanate ($BaTiO_3$) between two electrodes. Special features include high reliability, compact size, large capacitance, excellent high-frequency characteristics, and simple mass production. Furthermore, their low cost enables wide application in electronic circuits designed for by-pass, coupling, and resonant functions.

Ceramic capacitors are divided into two distinctive types according to structure —— monolithic and disc type.

The latter type is available in a larger variety, with rated voltages of 50V, 250V, 500V, 1KV, 2KV, 3.15KV, and 6.3KV, besides AC voltage. Murata has meanwhile developed its original BC capacitors —— semiconductive ceramic capacitors which are much more compact in size and much larger in capacitance than conventional ceramic capacitors. BC capacitors are available in rated voltages of 12V, 16V, 25V, and 50V.

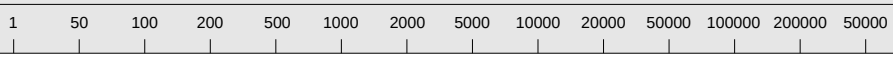
■ MURATA'S DISC TYPE CERAMIC CAPACITORS

DESCRIPTION	SERIES	TYPE 1	TYPE 2	TYPE 3	RATED VOLTAGE	CAPACITANCE RANGE (pF)
CERAMIC CAPACITOR	DD100 DD10	○	○	—	50V 500V	1 – 47000
BC CAPACITOR	DD300 DD400	—	—	○	12V 16V 25V 50V	1000 – 470000
HIGH-VOLTAGE CERAMIC CAPACITOR	CONVENTIONAL HIGH-VOLTAGE HR	○	○	○	250V 500V 1KV 2KV 3.15KV 6.3KV	10 – 10000
SAFETY STANDARD RECOGNIZED CERAMIC CAPACITOR	KH KX MX PRODUCTS WHICH ARE BASED ON THE STANDARDS OF THE ELECTRICAL APPLIANCE AND MATERIAL CONTOROL LAW OF JAPAN	—	○	—	125VAC 250VAC	100 – 10000

■ MURATA'S CERAMIC CAPACITORS

1. TABLE OF CAPACITANCE RANGE

Series	Rated Voltage (VDC)	Temp. Char.	Type	Nominal Capacitance Range (pF)
DD100	50	CΔ	1	1-270
		SL		1-1000
		B	2	100-10000
		F		2200-47000
DD10	500	CΔ	1	1-270
		SL		1-560
		B	2	100-10000
		E		1000-10000
DD300 (surface layer)	50	F	3	22000-100000
	25	F		22000-100000
	16	F		220000
	12	F		100000-470000
DD400 (Boundary Layer)	25	SR	3	1000-100000
	16	SR		10000-100000



2. PART NUMBERING

(*Please specify the part number when ordering.)

(Example) **DD104** **-63** **B** **101** **K** **50**

❶ ❷ ❸ ❹ ❺ ❻

❶Type

Series	Code
DD100 DD300 DD400	DDXXX DD plus the first digit denotes the series; the next two digits denote nominal body diameter. (Example) DD1 06 Nominal Body Dia. 6mm DD100 Series
DD10	DDXX The two digits denote the nominal body diameter. (Example) DD 07 Nominal Body Dia. 7.5mm

❷Lead Configuration

Code	Configuration
-63 -64	Inside Crimp
-959 -989 -999	Crimp Taping

❸Temperature Characteristics

Code	Cap. Change or Temp. Coeff.
CK	0±250 (ppm/˚C)
CJ	0±120 (ppm/˚C)
CH	0± 60 (ppm/˚C)
SL	+350 to -1000 (ppm/˚C)
B	Within ±10%
E	Within $^{+20}_{-55}$%
F	Within $^{+30}_{-80}$%
SR	Within ±15%

❹Nominal Capacitance

The first two digits denote significant figures; the last digit denotes the mulitiplier of 10 in pF.

(Example)

472=47X10²=4700pF

Photo	Special Feature and Application Fields
	High reliability and low cost due to simple structure. Low residual inductance permits application at high frequency. The temperature-compensating type, in particular, is much more stable than conventional capacitors against temperature variations. The temperature-compensating type is applied mainly in oscillation, tuning, and coupling circuits; the high dielectric-constant type in decoupling and by-pass capacitors.
	Widely used in electronic circuits for TV and power sources.
	BC capacitors have been designed to be more compact in size than the conventional ceramic capacitors and are available at a lower cost. The series is divided into two types by structure surface-layer and boundary-layer. The surface-layer series can be used in the same way as the high dielectric-constant type of ceramic capacitor. The boundary-layer series can replace polyester-film capacitors because of similar characteristics.

❺Capacitance Tolerance

Code	Tolerance
C	±0.25pF
D	±0.5pF
J	± 5%
K	±10%
M	±20%
P	$^{+100}_{-0}$%
Z	$^{+80}_{-20}$%

❻Rated Voltage

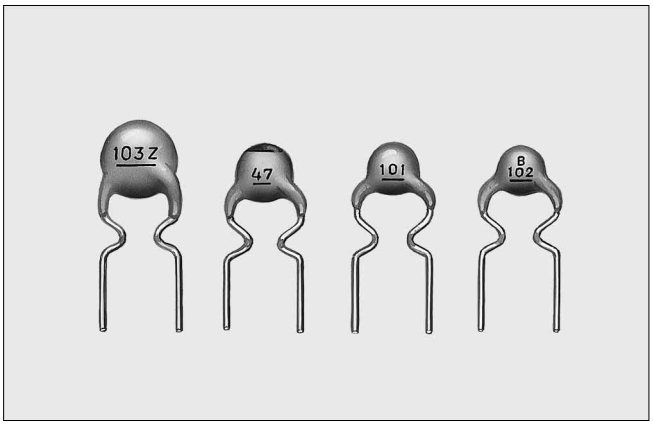
Code	Rated Voltage
12	12VDC
16	16VDC
25	25VDC
50	50VDC
500	500VDC

CERAMIC CAPACITOR

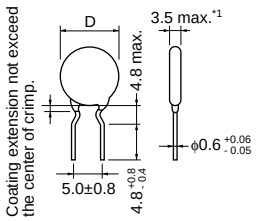
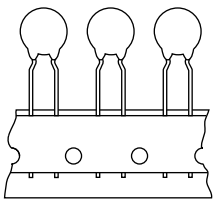
50V Ceramic Capacitor DD100 Series

■ FEATURES

1. High reliability and low cost.
2. Little residual inductance. Can be used in the high frequencies.
3. Temperature compensating type with high Q and stable against temperature changes.
4. 50V-capacitors are designed to be suitable for 63V-applications.



■ DIMENSIONS

Packaging form	Bulk	Taping*2
Configuration	Inside Crimp	Inside Crimp
Lead code	-63	-989, -999, -959
Dimensions (in mm)		 Lead spacing F : 5.0 Pitch of component P : 12.7 Pitch of sproket hole Po: 12.7

*1 4.0 max. in the case of temperature compensating type of 22pF and under, and high dielectric constant type of 470pF and under.
*2 Please see page 16 on other taping specification.

■ MARKING

Item \ Type / Temp. Char.	Temperature Compensating Type		High Dielectric Constant Type	
	CK, CJ, CH	SL	B	F
DD104-DD106	12	12	B 102	472
DD107 & DD108	121J	331J	B 332K	223Z M 67
DD109-DD112	271J M 67	561J M 67	B 682K M 67	473Z M 67
Temperature Characteristics	Identified by color (Black) .	Omitted.	Identified by code.	Omitted.
Nominal Capacitance	Under 100pF : Actual value. 100pF and over: Identified by 3-figure code.			
Capacitance Tolerance	Identified by code. Omitted for Nom. Dia. φ6mm and under except F103Z.			
Rated Voltage	Identified by horizontal line under capacitance.			
Manufacturer's Identification	Identified by M. Omitted for Nom. Dia. φ8mm and under except F223Z.			
Manufactured Date	Abbreviation. Omitted for Nom. Dia. φ8mm and under except F223Z.			

CERAMIC CAPACITOR

50V Ceramic Capacitor DD100 Series

■ STANDARD LIST

Temperature Compensating Type	DD100 Series

CK Characteristics (0±250 ppm/°C)
CJ Characteristics (0±120 ppm/°C)
CH Characteristics (0± 60 ppm/°C)

Nominal Capacitance (pF)	Body Dia. D (mm max.)	Capacitance Tolerance	Rated Voltage (VDC)	Part Number (□: means optional lead code shown on the right.)	Lead Code	
					Bulk	Taping
					Inside Crimp 	Crimp 
1	4	±0.25pF	50	DD104 □ CK 010 C 50	-63	-989
1.5				DD104 □ CK 1R5 C 50		
2				DD104 □ CK 020 C 50		
3				DD104 □ CJ 030 C 50		
4				DD104 □ CH 040 C 50		
5				DD104 □ CH 050 C 50		
6		±0.5pF		DD104 □ CH 060 D 50		
7				DD104 □ CH 070 D 50		
8				DD104 □ CH 080 D 50		
9				DD104 □ CH 090 D 50		
10				DD104 □ CH 100 D 50		
12		±5%		DD104 □ CH 120 J 50		
15				DD104 □ CH 150 J 50		
18				DD104 □ CH 180 J 50		
22				DD104 □ CH 220 J 50		
27				DD104 □ CH 270 J 50		
33				DD104 □ CH 330 J 50		
39				DD104 □ CH 390 J 50		
47				DD104 □ CH 470 J 50		
56	5			DD105 □ CH 560 J 50		
68	6			DD106 □ CH 680 J 50		-999
82				DD106 □ CH 820 J 50		
100	7.5			DD107 □ CH 101 J 50		-959
120				DD107 □ CH 121 J 50		
150	8			DD108 □ CH 151 J 50		
180	9.5			DD109 □ CH 181 J 50		
220				DD109 □ CH 221 J 50		
270	10.5			DD110 □ CH 271 J 50		

CERAMIC CAPACITOR

50V Ceramic Capacitor DD100 Series

Temperature Compensating Type	DD100 Series

SL Characteristics (+350 to -1000 ppm/°C)

Nominal Capacitance (pF)	Body Dia. D (mm max.)	Capacitance Tolerance	Rated Voltage (VDC)	Part Number (□: means optional lead code shown on the right.)	Lead Code: Bulk / Inside Crimp	Lead Code: Taping / Crimp
1	4	±0.25pF	50	DD104 □ SL 010 C 50	-63	-989
1.5				DD104 □ SL 1R5 C 50		
2				DD104 □ SL 020 C 50		
3				DD104 □ SL 030 C 50		
4				DD104 □ SL 040 C 50		
5				DD104 □ SL 050 C 50		
6		±0.5pF		DD104 □ SL 060 D 50		
7				DD104 □ SL 070 D 50		
8				DD104 □ SL 080 D 50		
9				DD104 □ SL 090 D 50		
10				DD104 □ SL 100 D 50		
12		±5%		DD104 □ SL 120 J 50		
15				DD104 □ SL 150 J 50		
18				DD104 □ SL 180 J 50		
22				DD104 □ SL 220 J 50		
27				DD104 □ SL 270 J 50		
33				DD104 □ SL 330 J 50		
39				DD104 □ SL 390 J 50		
47				DD104 □ SL 470 J 50		
56				DD104 □ SL 560 J 50		
68				DD104 □ SL 680 J 50		
82				DD104 □ SL 820 J 50		
100				DD104 □ SL 101 J 50		
120				DD104 □ SL 121 J 50		
150	5			DD105 □ SL 151 J 50		
180	6			DD106 □ SL 181 J 50		-999
220				DD106 □ SL 221 J 50		
270	7.5			DD107 □ SL 271 J 50		-959
330				DD107 □ SL 331 J 50		
390				DD107 □ SL 391 J 50		
470	8			DD108 □ SL 471 J 50		
560	9.5			DD109 □ SL 561 J 50		
680	10.5			DD110 □ SL 681 J 50		
820				DD110 □ SL 821 J 50		
1000	12.5			DD112 □ SL 102 J 50		—

CERAMIC CAPACITOR

50V Ceramic Capacitor DD100 Series

High Dielectric Constant Type	DD100 Series

B Characteristics (±10%)

Nominal Capacitance (pF)	Body Dia. D (mm max.)	Capacitance Tolerance (%)	Rated Voltage (VDC)	Part Number (□: means optional lead code shown on the right.)	Lead Code: Bulk, Inside Crimp	Lead Code: Taping, Crimp
100	4	±10	50	DD104 □ B 101 K 50	-63	-989
120				DD104 □ B 121 K 50		
150				DD104 □ B 151 K 50		
180				DD104 □ B 181 K 50		
220				DD104 □ B 221 K 50		
270				DD104 □ B 271 K 50		
330				DD104 □ B 331 K 50		
390				DD104 □ B 391 K 50		
470				DD104 □ B 471 K 50		
560				DD104 □ B 561 K 50		
680				DD104 □ B 681 K 50		
820				DD104 □ B 821 K 50		
1000				DD104 □ B 102 K 50		
1200				DD104 □ B 122 K 50		
1500				DD104 □ B 152 K 50		
1800	5			DD105 □ B 182 K 50		
2200	6			DD106 □ B 222 K 50		-999
2700				DD106 □ B 272 K 50		
3300	7.5			DD107 □ B 332 K 50		-959
3900				DD107 □ B 392 K 50		
4700				DD107 □ B 472 K 50		
5600	8			DD108 □ B 562 K 50		
6800	9.5			DD109 □ B 682 K 50		
8200	10.5			DD110 □ B 822 K 50		
10000	11			DD111 □ B 103 K 50		

F Characteristics ($^{+30}_{-80}$%)

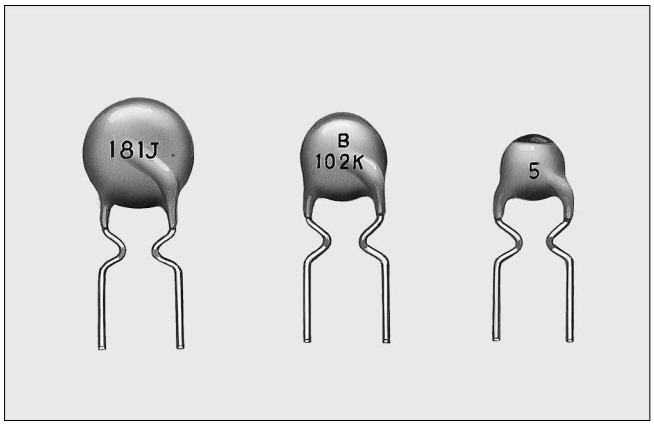
Nominal Capacitance (pF)	Body Dia. D (mm max.)	Capacitance Tolerance (%)	Rated Voltage (VDC)	Part Number (□: means optional lead code shown on the right.)	Lead Code: Bulk, Inside Crimp	Lead Code: Taping, Crimp
2200	4	+80 -20	50	DD104 □ F 222 Z 50	-63	-989
4700				DD104 □ F 472 Z 50		
6800	5			DD105 □ F 682 Z 50		
10000	6			DD106 □ F 103 Z 50		-999
22000	8			DD108 □ F 223 Z 50		-959
47000	10.5			DD110 □ F 473 Z 50		

CERAMIC CAPACITOR

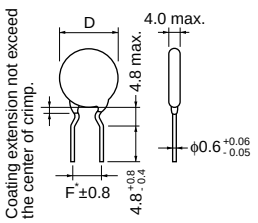
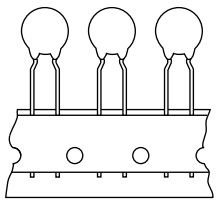
500V Ceramic Capacitor DD10 Series

■ FEATURES

1. High reliability and low cost.
2. Little residual inductance. Can be used in the high frequencies.
3. Temperature compensating type with high Q and stable against temperature changes.



■ DIMENSIONS

Packaging form	Bulk	Taping *2
Configuration	Inside Crimp	Inside Crimp
Lead code	-63, -64	-989, -999, -959
Dimensions (in mm)		 Lead spacing F : 5.0 Pitch of component P : 12.7 Pitch of sproket hole P_0: 12.7

*1 F: 5.0 (Lead code : -63) or F: 10.0 (Lead code: -64)
*2 Please see page 16 on other taping specification.

■ MARKING

Item \ Type / Temp. Char.	Temperature Compensating Type		High Dielectric Constant Type	
	CK, CJ, CH	SL	B	E
DD05&DD06	10	10	B 101	E 102
DD07&DD08	33J	181J	B 122K	E 222P
DD09-DD18	221J M 67	561J M 67	B 103K M 67	E 103P M 67
Temperature Characteristics	Identified by color (Black).	Omitted.	Identified by code.	Identified by code.
Nominal Capacitance	Under 100pF : Actual value. 100pF and over: Identified by 3-figure code.			
Capacitance Tolerance	Identified by code. Omitted for Nom. Dia. φ6mm and under.			
Rated Voltage	Omitted.			
Manufacturer's Identification	Identified by M. Omitted for Nom. Dia. φ8mm and under.			
Manufactured Date	Abbreviation. Omitted for Nom. Dia. φ8mm and under.			

CERAMIC CAPACITOR

500V Ceramic Capacitor DD10 Series

■ STANDARD LIST

Temperature Compensating Type	DD10 Series

CK Characteristics (0±250 ppm/˚C)
CJ Characteristics (0±120 ppm/˚C)
CH Characteristics (0± 60 ppm/˚C)

Nominal Capacitance (pF)	Body Dia. D (mm max.)	Capacitance Tolerance	Rated Voltage (VDC)	Part Number (□:means optional lead code shown on the right.)	Lead Code: Bulk, Inside Crimp	Lead Code: Taping, Crimp
1	5	±0.25pF	500	DD05 □ CK 010 C 500	-63	-989
1.5				DD05 □ CK 1R5 C 500		
2				DD05 □ CK 020 C 500		
3				DD05 □ CJ 030 C 500		
4				DD05 □ CH 040 C 500		
5				DD05 □ CH 050 C 500		
6		±0.5pF		DD05 □ CH 060 D 500		
7				DD05 □ CH 070 D 500		
8				DD05 □ CH 080 D 500		
9				DD05 □ CH 090 D 500		
10				DD05 □ CH 100 D 500		
12		±5%		DD05 □ CH 120 J 500		
15				DD05 □ CH 150 J 500		
18				DD05 □ CH 180 J 500		
22				DD05 □ CH 220 J 500		
27	6			DD06 □ CH 270 J 500		-999
33	7.5			DD07 □ CH 330 J 500		-959
39				DD07 □ CH 390 J 500		
47				DD07 □ CH 470 J 500		
56	8			DD08 □ CH 560 J 500		
68	9.5			DD09 □ CH 680 J 500		
82				DD09 □ CH 820 J 500		
100	10.5			DD10 □ CH 101 J 500		
120				DD10 □ CH 121 J 500		
150	11			DD11 □ CH 151 J 500		
180	12.5			DD12 □ CH 181 J 500		—
220	14.5			DD14 □ CH 221 J 500	-64	
270				DD14 □ CH 271 J 500		

CERAMIC CAPACITOR

500V Ceramic Capacitor DD10 Series

Temperature Compensating Type	DD10 Series

SL Characteristics (+350 to -1000ppm/˚C)

Nominal Capacitance (pF)	Body Dia. D (mm max.)	Capacitance Tolerance	Rated Voltage (VDC)	Part Number (□: means optional lead code shown on the right.)	Lead Code: Bulk / Inside Crimp	Lead Code: Taping / Crimp
1	5	±0.25pF	500	DD05 □ SL 010 C 500	-63	-989
1.5				DD05 □ SL 1R5 C 500		
2				DD05 □ SL 020 C 500		
3				DD05 □ SL 030 C 500		
4				DD05 □ SL 040 C 500		
5				DD05 □ SL 050 C 500		
6		±0.5pF		DD05 □ SL 060 D 500		
7				DD05 □ SL 070 D 500		
8				DD05 □ SL 080 D 500		
9				DD05 □ SL 090 D 500		
10				DD05 □ SL 100 D 500		
12		±5%		DD05 □ SL 120 J 500		
15				DD05 □ SL 150 J 500		
18				DD05 □ SL 180 J 500		
22				DD05 □ SL 220 J 500		
27				DD05 □ SL 270 J 500		
33				DD05 □ SL 330 J 500		
39				DD05 □ SL 390 J 500		
47				DD05 □ SL 470 J 500		
56				DD05 □ SL 560 J 500		
68				DD05 □ SL 680 J 500		
82	6			DD06 □ SL 820 J 500		-999
100				DD06 □ SL 101 J 500		
120	7.5			DD07 □ SL 121 J 500		-959
150				DD07 □ SL 151 J 500		
180	8			DD08 □ SL 181 J 500		
220	9.5			DD09 □ SL 221 J 500		
270				DD09 □ SL 271 J 500		
330	10.5			DD10 □ SL 331 J 500		
390				DD10 □ SL 391 J 500		
470	11			DD11 □ SL 471 J 500		
560	12.5			DD12 □ SL 561 J 500		—

CERAMIC CAPACITOR

500V Ceramic Capacitor DD10 Series

High Dielectric Constant Type	DD10 Series

B Characteristics (±10%)

Nominal Capacitance (pF)	Body Dia. D (mm max.)	Capacitance Tolerance (%)	Rated Voltage (VDC)	Part Number (□:means optional lead code shown on the right.)	Lead Code: Bulk Inside Crimp	Lead Code: Taping Crimp
100	5	±10	500	DD05 □ B 101 K 500	-63	-989
120				DD05 □ B 121 K 500		
150				DD05 □ B 151 K 500		
180				DD05 □ B 181 K 500		
220				DD05 □ B 221 K 500		
270				DD05 □ B 271 K 500		
330				DD05 □ B 331 K 500		
390				DD05 □ B 391 K 500		
470				DD05 □ B 471 K 500		
560				DD05 □ B 561 K 500		
680	6			DD06 □ B 681 K 500		-999
820				DD06 □ B 821 K 500		
1000	7.5			DD07 □ B 102 K 500		-959
1200				DD07 □ B 122 K 500		
1500	8			DD08 □ B 152 K 500		
1800				DD08 □ B 182 K 500		
2200	9.5			DD09 □ B 222 K 500		
2700	10.5			DD10 □ B 272 K 500		
3300	11			DD11 □ B 332 K 500		
3900				DD11 □ B 392 K 500		
4700	12.5			DD12 □ B 472 K 500		—
5600	14.5			DD14 □ B 562 K 500	-64	
6800				DD14 □ B 682 K 500		
8200	16.5			DD16 □ B 822 K 500		
10000	18.5			DD18 □ B 103 K 500		

E Characteristics($^{+20}_{-55}$%)

Nominal Capacitance (pF)	Body Dia. D (mm max.)	Capacitance Tolerance (%)	Rated Voltage (VDC)	Part Number (□:means optional lead code shown on the right.)	Lead Code: Bulk Inside Crimp	Lead Code: Taping Crimp
1000	6	+100 - 0	500	DD06 □ E 102 P 500	-63	-999
1500	7.5			DD07 □ E 152 P 500		-959
2200	8			DD08 □ E 222 P 500		
3300	9.5			DD09 □ E 332 P 500		
4700	10.5			DD10 □ E 472 P 500		
6800	12.5			DD12 □ E 682 P 500		—
10000	14.5			DD14 □ E 103 P 500	-64	

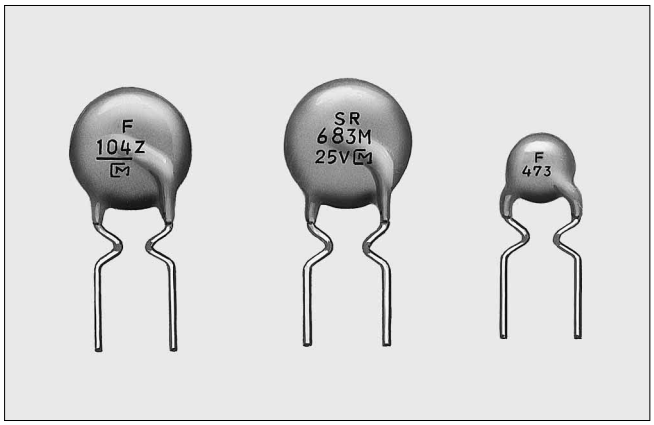
BC CAPACITOR

12/16/25/50V BC Capacitor DD300/DD400 Series

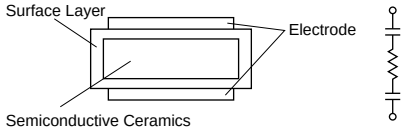
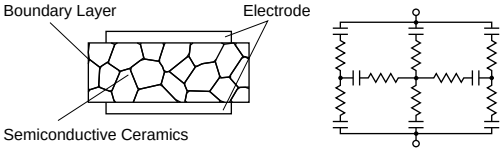
■ FEATURES

Murata has devoted constant effort to developing semi-conductive ceramics technology. We design capacitors in much more compact sizes than conventional ceramic capacitors, having reduced the diameter by 50% and the effective thickness by 90% Capacitance values available are 0.001 to 0.47μF, perfect for meeting the need for high density assemblies.

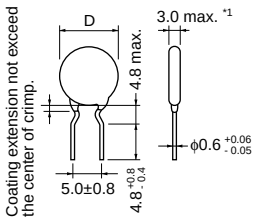
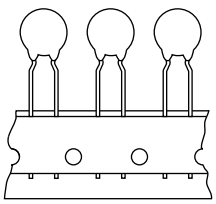
There are two kinds of BC capacitors, both designated by their inside construction ― DD300 series (Surface layer type) and DD400 series (Boundary layer type) .



■ COMPARATIVE LIST OF EACH SERIES

Series / Item	DD300 Series (Surface Layer)	DD400 Series (Boundary Layer)
Inside Construction and Equivalent Circuit		

■ DIMENSIONS

Packaging form	Bulk	Taping*2
Configuration	Inside Crimp	Inside Crimp
Lead code	-63	-989, -999, -959
Dimensions (in mm)		 Lead spacing F : 5.0 Pitch of component P : 12.7 Pitch of sproket hole P0: 12.7

*1 3.5mm max. in case of DD312

*2 Please see page 16 on other taping specification.

BC CAPACITOR

12/16/25/50V BC Capacitor DD300/DD400 Series

■ MARKING

Series	DD300 Series		DD400 Series	
Temp. Char. / Rated Voltage / Type	F		Temp. Char. / Rated Voltage / Type	SR
	12V 16V 25V	50V		16V 25V
DD304 DD305	F 473	F 223	DD404 DD405	SR 102M
DD306	F 104Z 25V	F 473Z	DD406 DD407	SR 473M 25V
DD308	F 224Z 12V M	F 104Z M	DD408	SR 683M 25V M
DD310 DD312	F 334Z 12V M 67	—	DD410	SR 104M 25V M 67
Temperature Characteristics	Identified by code.		Identified by code.	
Nominal Capacitance	Identified by 3-figure code.		Identified by 3-figure code.	
Capacitance Tolerance	Identified by code. Omitted for Nom. Dia. ϕ5mm and under.		Identified by code.	
Rated Voltage	12/16/25V: Identified by code. Omitted for Nom. Dia. ϕ5mm and under. 50V: Identified by horizontal line (–) under capacitance.		Identified by code. Omitted for Nom. Dia. ϕ5mm and under.	
Manufacturer's Identification	Identified by M. Omitted for Nom. Dia. ϕ6.3mm and under.		Identified by M. Omitted for Nom. Dia. ϕ7mm and under.	
Manufactured Date	Abbreviation. Omitted for Nom. Dia. ϕ8mm and under.		Abbreviation. Omitted for Nom. Dia. ϕ8mm and under.	

* Marking of color: color of red

■ STANDARD LIST

DD300 Series

F Characteristics ($^{+30}_{-80}$%)

Nominal Capacitance (pF)	Body Dia. D (mm)	Capacitance Tolerance (%)	Rated Voltage (VDC)	Part Number (□: means optional lead code shown on the right.)	Lead Code: Bulk (Inside Crimp)	Lead Code: Taping (Crimp)
100000	5±1	+80 -20	12	DD305 □ F 104 Z 12	-63	-999
220000	8±1			DD308 □ F 224 Z 12		-959
330000	10±1			DD310 □ F 334 Z 12		
470000	12.5±1.3			DD312 □ F 474 Z 12		—
220000	10±1		16	DD310 □ F 224 Z 16		-959
22000	4±1		25	DD304 □ F 223 Z 25		-989
33000				DD304 □ F 333 Z 25		
47000				DD304 □ F 473 Z 25		
100000	6.3±1			DD306 □ F 104 Z 25		-959
22000	4±1		50	DD304 □ F 223 Z 50		-989
33000	5±1			DD305 □ F 333 Z 50		-999
47000	6.3±1			DD306 □ F 473 Z 50		-959
100000	8±1			DD308 □ F 104 Z 50		

BC CAPACITOR

12/16/25/50V BC Capacitor DD300/DD400 Series

DD400 Series

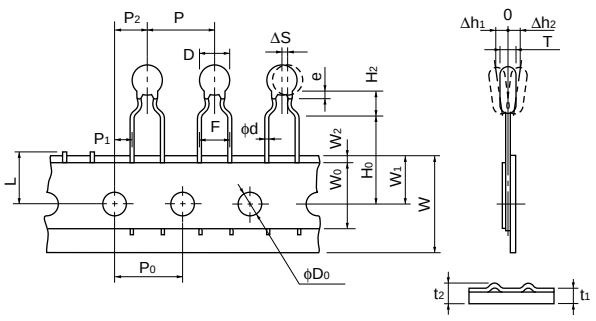
SR Characteristics (±15%)

Nominal Capacitance (pF)	Body Dia. D (mm)	Capacitance Tolerance (%)	Rated Voltage (VDC)	Part Number (□: means optional lead code shown on the right.)	Lead Code: Bulk, Inside Crimp	Lead Code: Taping, Crimp
10000	4±1	±20	16	DD404 □ SR 103 M 16	-63	-989
12000				DD404 □ SR 123 M 16		
15000				DD404 □ SR 153 M 16		
18000				DD404 □ SR 183 M 16		
22000				DD404 □ SR 223 M 16		
27000	5±1			DD405 □ SR 273 M 16		-999
33000				DD405 □ SR 333 M 16		
39000				DD405 □ SR 393 M 16		
47000				DD405 □ SR 473 M 16		
56000	6.3±1			DD406 □ SR 563 M 16		-959
68000				DD406 □ SR 683 M 16		
82000	7±1			DD407 □ SR 823 M 16		
100000				DD407 □ SR 104 M 16		
1000	4±1		25	DD404 □ SR 102 M 25		-989
1200				DD404 □ SR 122 M 25		
1500				DD404 □ SR 152 M 25		
1800				DD404 □ SR 182 M 25		
2200				DD404 □ SR 222 M 25		
2700				DD404 □ SR 272 M 25		
3300				DD404 □ SR 332 M 25		
3900				DD404 □ SR 392 M 25		
4700				DD404 □ SR 472 M 25		
5600				DD404 □ SR 562 M 25		
6800				DD404 □ SR 682 M 25		
8200				DD404 □ SR 822 M 25		
10000				DD404 □ SR 103 M 25		
12000				DD404 □ SR 123 M 25		
15000				DD404 □ SR 153 M 25		
18000	5±1			DD405 □ SR 183 M 25		-999
22000				DD405 □ SR 223 M 25		
27000	6.3±1			DD406 □ SR 273 M 25		-959
33000				DD406 □ SR 333 M 25		
39000	7±1			DD407 □ SR 393 M 25		
47000				DD407 □ SR 473 M 25		
56000	8±1			DD408 □ SR 563 M 25		
68000				DD408 □ SR 683 M 25		
82000	10±1			DD410 □ SR 823 M 25		
100000				DD410 □ SR 104 M 25		

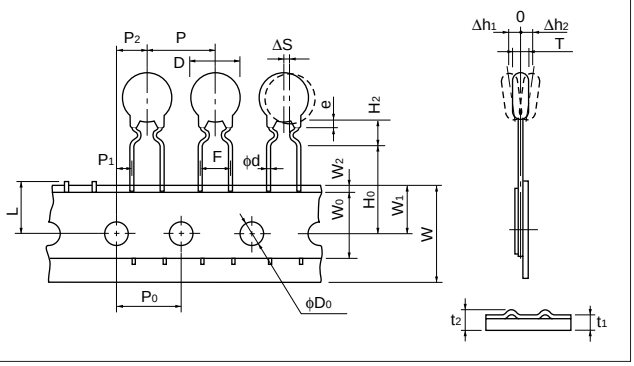
• Capacitance tolerance K (±10%) is also available.

4. TAPING SPECIFICATIONS

Lead Code : -989, -999



Lead Code : -959



Item	Code	Dimensions(mm)
Pitch of component	P	12.7
Pitch of sproket hole	P_0	12.7±0.3
Lead spacing	F	$5.0^{+0.8}_{-0.2}$
Length from hole center to component center	P_2	6.35±1.3
Length from hole center to lead	P_1	3.85±0.7
Body diameter	D	See the individual product specification
Deviation along tape, left or right	ΔS	0±1.0
Carrier tape width	W	18.0±0.5
Position of sproket hole	W_1	9.0±0.5
Lead distance between reference and bottom planes	H_2	6.0 max. (-989)
		5.0 max. (-999)
		4.8 max. (-959)
	H_0	16.0±0.5

Item	Code	Dimensions(mm)
Diameter of sproket hole	ϕD_0	4.0±0.1
Lead diameter	φd	$0.6^{+0.06}_{-0.05}$
Total tape thickness	t_1	0.6±0.3
Total thickness, tape and lead wire	t_2	1.5 max.
Body thickness	T	See the individual product specification
Deviation across tape	Δh_1, Δh_2	1.0 max.
Portion to cut in case of defect	L	$11.0^{+0}_{-1.0}$
Hold down tape width	W_0	9.5 min.
Hold down tape position	W_2	1.5±1.5
Coating extension on lead	e	Up to the center of crimp

5. PACKAGING STYLES

Bulk	Taping
Polyethlyene Bag	Flat Pack
	

■ **Minimum Quantity* (Order in Sets Only)**

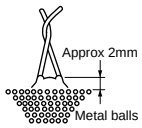
[Bulk] 1,000 (pcs.) **[Taping]** 2,000 (pcs.)

■ **Minimum Order Quantity** 10,000 (pcs.)

***** "Minimum Quantity" means the numbers of units of each delivery or order. The quantity should be an integral multiple of the "minimum quantity".
(Please note that the actual delivery quantity in a package may change sometimes.)

6. SPECIFICATION AND TEST METHOD

6-1. TEMPERATURE COMPENSATING TYPE DD100/DD10 Series

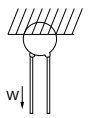
Item			Specification	Testing Method
1	OperatingTemperatureRange		-25 to +85˚C	——
2	Capacitance		Within specified tolerance.	The capacitance shall be measured at 20˚C with 1±0.2MHz and 5Vrms max.
3	Q		C>=30pF: Q>=1000 C<30pF: Q>=400+20C*1	Same condition as capacitance.
4	Insulation Resistance (I. R.)		10000MΩ min.	The insulation resistance shall be measured with 10±1V (500±50V for DD10 Series) within 60±5 sec. of charging.
5	Dielectric Strength	Between lead wires	No failure.	The capacitors shall not be damage when DC voltage of 300% of the rated voltage are applied between the lead wires for 1 to 5 sec. (Charge/discharge current =<50mA)
		Body Insulation	No failure.	The capacitor is placed in the container with metal balls of diameter 1mm so that each lead wire, short-circuited, is kept approximately 2mm off the balls as shown in the figure, and DC voltage of 250% of the rated voltage is applied for 1 to 5 sec. between capacitor lead wires and small metals. (Charge/discharge current =<50mA) 
6	Temperature Characteristic	Temperature Coefficient	Within specified tolerance. (See Table A)	The capacitance measurement shall be made at each step specified in table. Capacitance change from the value of step 3 shall not exceed the limit specified.
		Capacitance Drift	Within ±0.2% or ±0.05pF whichever is greater.	
7	Vibration Resistance	Appearance	No marked defect.	The capacitor shall firmly be soldered to the supporting lead wire and vibration which is 10 to 55Hz in the vibration frequency range. 1.5mm in total amplitude, and about 1 minute in the rate of vibration change from 10Hz to 55Hz and back to 10Hz is applied for a total of 6 hours; 2 hours each in 3 mutually perpendicular directions.
		Capacitance	Within specified tolerance.	
		Q	C>=30pF: Q>=1000 C<30pF: Q>=400+20C*1	
8	Soldering Effect	Appearance	No marked defect.	The lead wire shall be immersed into the melted solder of 350±10˚C (Nominal body diameter ϕ5mm and under 270±5˚C) up to about 1.5 to 2mm from the main body for 3.5±0.5 sec. (Nominal body diameter ϕ5mm and under 5±0.5 sec.) Post-treatment: Capacitor shall be stored for 1 to 2 hours at *2room condition.
		Capacitance Change	Within ±2.5% or ±0.25pF whichever is greater.	
		Dielectric Strength (Between lead wires)	Pass the item No. 5.	
9	Humidity (Under steady state)	Appearance	No marked defect.	Set the capacitor for 500^{+24}_{-0} hours at 40±2˚C in 90 to 95% humidity. Post-treatment: Capacitor shall be stored for 1 to 2 hours at *2room condition.
		Capacitance Change	Within ±5% or ±0.5pF whichever is greater.	
		Q	C>=30pF : Q>=350 10=<C<30pF: Q>=275+ $\frac{5}{2}$ C*1 C<10pF : Q>=200+10C*1	
		I. R.	1000MΩ min.	
		Dielectric Strength (Between lead wires)	Pass the item No. 5.	

*1 "C" expresses nominal capacitance value (pF) .

*2 "room condition" temperature: 15-35˚C humidity: 45-75% atmospheric pressure: 86-106kPa

Table A

Char.	Temp. Coeff. (ppm/˚C) between +20˚C and +85˚C	Cap. Change (%) between+20˚C and -25˚C		Char.	Temp. Coeff. (ppm/˚C) between +20˚C and +85˚C	Cap. Change (%) between+20˚C and -25˚C	
		max.	min.			max.	min.
CK	0±250	1.54	-1.13	CH	0± 60	0.49	-0.27
CJ	0±120	0.82	-0.54	SL	+350 to -1000	—	—

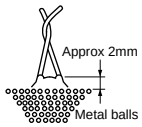
Item			Specification	Testing Method
10	Humidity Loading	Appearance	No marked defect.	Apply the rated voltage for 500^{+24}_{0} hours at 40±2˚C in 90 to 95% humidity. Post-treatment: Capacitor shall be stored for 1 to 2 hours at *2room condition. (Charge/discharge current =<50mA)
		Capacitance Change	Within ±7.5% or ±0.75pF whichever is greater.	
		Q	C>=30pF: Q>=200 C<30pF: Q>=100+$\frac{10}{3}$C*1	
		I. R.	500MΩ min.	
		Dielectric Strength (Between lead wires)	Pass the item No. 5.	
11	Life	Appearance	No marked defect.	Apply a DC voltage of 200% of the rated voltage for 1000^{+48}_{0} hours at 85±2˚C. Post-treatment: Capacitor shall be stored for 1 to 2 hours at *2room condition. (Charge/discharge current =<50mA)
		Capacitance Change	Within ±3% or ±0.3pF whichever is greater.	
		Q	C>=30pF : Q>=350 10=<C<30pF : Q>=275+$\frac{5}{2}$ C*1 C<10pF : Q>=200+10C*1	
		I. R.	2000MΩ min.	
		Dielectric Strength (Between lead wires)	Pass the item No. 5.	
12	Temperature and immersion cycling	Appearance	No marked defect.	The capacitor shall be subjected to 5 cycles of temperature variation according to Table 1, then the capacitor shall be immersed into two baths, the one a clean water bath at temperature 65^{+5}_{-0}˚C and the other a saturated salt water bath at temperature 0±3˚C for 15 minutes. This immersion cycle shall be repeated 2 times, then the capacitor shall be washed in running water, wiped or dried with air draught. Post-treatment: Capacitor shall be stored for 1 to 2 hours at *2room condition. (Table 1)
		Capacitance Change	Within ±5% or ±0.5pF whichever is greater.	
		Q	C>=30pF : Q>=350 10=<C<30pF : Q>=275+$\frac{5}{2}$ C*1 C<10pF : Q>=200+10C*1	
		I. R.	1000MΩ min.	
		Dielectric Strength (Between lead wires)	Pass the item No. 5.	
13	Strength of Lead	Pull	Lead wire shall not cut off. Capacitor shall not be broken.	As a figure, fix the body of capacitor, apply a tensile weight gradually to each lead wire in the radial direction of capacitor up to 10N (1.0kgf) and keep it for 10±1 sec. 
		Bending		Each lead wire shall be subjected to 5N (0.51kgf) weight and then a 90˚ bend, at the point of egress, in one direction return to original position, and then a 90˚ bend in the opposite direction at the rate of one bend in 2 to 3 seconds.
14	Solderability of Leads		Lead wire shall be soldered with uniformly coated on the axial direction over $\frac{3}{4}$ of the circumferential direction.	The lead wire of a capacitor shall be dipped into a methanol solution of 25 wt% rosin and then into molten solder of 235±5˚C for 2±0.5 seconds. In both cases the depth of dipping is up to about 1.5 to 2.0mm from the root of lead wires.

(Table 1)

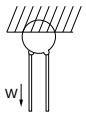
Step	Temperature (˚C)	Time
1	-25^{+0}_{-3}	30 minutes
2	room temp.	3 minutes
3	85^{+3}_{-0}	30 minutes
4	room temp.	3 minutes

*1 "C" expresses nominal capacitance value (pF).
*2 "room condition" temperature : 15-35˚C humidity : 45-75% atmospheric pressure : 86-106kPa

6-2. HIGH DIELECTRIC CONSTANT TYPE DD100/DD10 Series

<table>
<tr><th colspan="3">Item</th><th>Specification</th><th>Testing Method</th></tr>
<tr><td>1</td><td colspan="2">Operating Temperature Range</td><td>-25 to +85˚C</td><td>—</td></tr>
<tr><td>2</td><td colspan="2">Capacitance</td><td>Within specified tolerance.</td><td>The capacitance shall be measured at 20˚C with 1±0.2kHz and 5Vrms max.</td></tr>
<tr><td>3</td><td colspan="2">Dissipation Factor (D. F.)</td><td>B/E: D. F.=<2.5%
F : D. F.=<5.0%</td><td>Same condition as capacitance.</td></tr>
<tr><td>4</td><td colspan="2">Insulation Resistance (I. R.)</td><td>C*1=<0.02μF: 10000MΩ min.
C*1>0.02μF: 7500MΩ min.</td><td>The insulation resistance shall be measured with 10±1V (500±50V for DD10 Series) within 60±5 sec. of charging.</td></tr>
<tr><td rowspan="2">5</td><td rowspan="2">Dielectric Strength</td><td>Between lead wires</td><td>No failure.</td><td>The capacitors shall not be damage when DC voltage of 250% of the rated voltage are applied between the lead wires for 1 to 5 sec.
(Charge/discharge current=<50mA)</td></tr>
<tr><td>Body Insulation</td><td>No failure.</td><td>The capacitor is placed in the container with metal balls of diameter 1mm so that each lead wire, short-circuited, is kept approximately 2mm off the balls as shown in the figure, and DC voltage of 250% of the rated voltage is applied for 1 to 5 sec. between capacitor lead wires and small metals.
(Charge/discharge current=<50mA)
  </td></tr>
<tr><td rowspan="2">6</td><td rowspan="2">Temperature Characteristic</td><td>No DC voltage</td><td>B: Within ±10%
E: Within $^{+20}_{-55}$%
F: Within $^{+30}_{-80}$%</td><td rowspan="2">The capacitance measurement shall be made at each step specified in table and at a sufficient number of intermediate temperatures between step 2 and 7.
Capacitance change from the value of step 3 shall not exceed the limit specified.
<table><tr><th>Step</th><th>1</th><th>2</th><th>3</th><th>4</th></tr><tr><td>Temp.</td><td>20±2˚C</td><td>-25±3˚C</td><td>20±2˚C</td><td>85±2˚C</td></tr><tr><td>DC Voltage applied</td><td>None</td><td>None</td><td>None</td><td>None</td></tr></table><table><tr><th>Step</th><th>5</th><th>6</th><th>7</th><th>8</th></tr><tr><td>Temp.</td><td>85±2˚C</td><td>20±2˚C</td><td>-25±3˚C</td><td>20±2˚C</td></tr><tr><td>DC Voltage applied</td><td>Rated</td><td>Rated</td><td>Rated</td><td>Rated</td></tr></table>Pre-treatment: Capacitor shall be stored at 85±2˚C for 1 hour, then placed at *2room condition for 24±2 hours before measurements.</td></tr>
<tr><td>With DC voltage</td><td>B: Within $^{+10}_{-20}$%
E: Within $^{+20}_{-80}$%
F: Within $^{+30}_{-95}$%</td></tr>
<tr><td rowspan="3">7</td><td rowspan="3">Vibration Resistance</td><td>Appearance</td><td>No marked defect.</td><td rowspan="3">The capacitor shall firmly be soldered to the supporting lead wire and vibration which is 10 to 55Hz in the vibration frequency range. 1.5mm in total amplitude, and about 1 minute in the rate of vibration change from 10Hz to 55Hz and back to 10Hz is applied for a total of 6 hours; 2 hours each in 3 mutually perpendicular directions.</td></tr>
<tr><td>Capacitance</td><td>Within specified tolerance.</td></tr>
<tr><td>D. F.</td><td>Satisfies initial requirement.</td></tr>
<tr><td rowspan="3">8</td><td rowspan="3">Soldering Effect</td><td>Appearance</td><td>No marked defect.</td><td rowspan="3">The lead wire shall be immersed into the melted solder of 350±10˚C (Nominal body diameter ϕ5mm and under 270±5˚C) up to about 1.5 to 2mm from the main body for 3.5±0.5 sec. (Nominal body diameter ϕ5mm and under 5±0.5 sec.)
Pre-treatment: Capacitor shall be stored at 85±2˚C for 1 hour, then placed at *2room condition for 24±2 hours before initial measurements.
Post-treatment: Capacitor shall be stored for 24±2 hours at *2room condition.</td></tr>
<tr><td>Capacitance Change</td><td>B: Within ± 5%
E: Within ±15%
F: Within ±20%</td></tr>
<tr><td>Dielectric Strength (Between lead wires)</td><td>Pass the item No. 5.</td></tr>
<tr><td rowspan="5">9</td><td rowspan="5">Humidity (Under steady state)</td><td>Appearance</td><td>No marked defect.</td><td rowspan="5">Set the capacitor for 500$^{+24}_{0}$ hours at 40±2˚C in 90 to 95% humidity.
Pre-treatment: Capacitor shall be stored at 85±2˚C for 1 hour, then placed at *2room condition for 24±2 hours before initial measurements.
Post-treatment: Capacitor shall be stored for 1 to 2 hours at *2room condition.</td></tr>
<tr><td>Capacitance Change</td><td>B: Within ±10%
E: Within ±20%
F :Within ±30%</td></tr>
<tr><td>D. F.</td><td>B/E: D. F.=<5.0%
F : D. F.=<7.5%</td></tr>
<tr><td>I. R.</td><td>1000MΩ min.</td></tr>
<tr><td>Dielectric Strength (Between lead wires)</td><td>Pass the item No. 5.</td></tr>
</table>

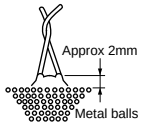
*1 "C" expresses nominal capacitance value (pF).
*2 "room condition" temperature: 15-35˚C humidity: 45-75% atmospheric pressure: 86-106kPa

Item			Specification	Testing Method
10	Humidity Loading	Appearance	No marked defect.	Apply the rated voltage for 500$^{+24}_{-0}$ hours at 40±2˚C in 90 to 95% humidity. Pre-treatment: Capacitor shall be stored at 85±2˚C for 1 hour, then placed at *2room condition for 24±2 hours before initial measurements. Post-treatment: Capacitor shall be stored for 1 to 2 hours at *2room condition. (Charge/discharge current=<50mA)
		Capacitance Change	B: Within ±10% E: Within ±20% F: Within ±30%	
		D. F.	B/E: D. F.=<5.0% F : D. F.=<7.5%	
		I. R.	500MΩ min.	
		Dielectric Strength (Between lead wires)	Pass the item No. 5.	
11	Life	Appearance	No marked defect.	Apply a DC voltage of 200% of the rated voltage for voltage for 1000$^{+48}_{-0}$ hours at 85±2˚C. Pre-treatment: Capacitor shall be stored at 85±2˚C for 1 hour, then placed at *2room condition for 24±2 hours before initial measurements. Post-treatment: Capacitor shall be stored for 24±2 hours at *2room condition. (Charge/discharge current=<50mA)
		Capacitance Change	B: Within ±10% E: Within ±20% F: Within ±30%	
		D. F.	B/E: D. F.=<4.0% F : D. F.=<7.5%	
		I. R.	2000MΩ min.	
		Dielectric Strength (Between lead wires)	Pass the item No. 5.	
12	Temperature and immersion cycling	Appearance	No marked defect.	The capacitor shall be subjected to 5 cycles of temperature variation according to Table 1. then the capacitor shall be immersed into two baths, the one a clean water bath at temperature 65$^{+5}_{-0}$˚C and the other a saturated salt water bath at temperature 0±3˚C for 15 minutes. This immersion cycle shall be repeated 2 times, then the capacitor shall be washed in running water, wiped or dried with air draugth. Pre-treatment: Capacitor shall be stored at 85±2˚C for 1 hour, then placed at *2room condition for 24±2 hours before initial measurements. Post-treatment: Capacitor shall be stored for 24±2 hours at *2room condition. (Table1)
		Capacitance Change	B: Within ±10% E: Within ±20% F: Within ±30%	
		D. F.	B/E: D. F.=<5.0% F : D. F.=<7.5%	
		I. R.	1000MΩ min.	
		Dielectric Strength (Between lead wires)	Pass the item No. 5.	
13	Strength of Lead	Pull	Lead wire shall not cut off. Capacitor shall not be broken.	As a figure, fix the body of capacitor, apply a tensile weight gradually to each lead wire in the radial direction of capacitor up to 10N (1.0kgf) and keep it for 10±1 sec. 
		Bending		Each lead wire shall be subjected to 5N (0.51kgf) weight and then a 90˚ bend, at the point of egress, in one direction, return to original position, and then a 90˚ bend in the opposite direction at the rate of one bend in 2 to 3 seconds.
14	Solderability of Leads		Lead wire shall be soldered with uniformly coated on the axial direction over $\frac{3}{4}$ of the circumferential direction.	The lead wire of a capacitor shall be dipped into a methanol solution of 25wt% rosin and then into molten solder of 235±5˚C for 2±0.5 seconds. In both cases the depth of dipping is up to about 1.5 to 2.0mm from the root of lead wires.

Step	Temperature (˚C)	Time
1	-25$^{+0}_{-3}$	30 minutes
2	room temp.	3 minutes
3	85$^{+3}_{-0}$	30 minutes
4	room temp.	3 minutes

*2 "room condition" temperature: 15-35˚C humidity: 45-75% atmospheric pressure: 86-106kPa

6-3. SEMICONDUCTIVE DIELECTRIC TYPE DD300/DD400 Series

Item			Specification	Testing Method
1	Operating Temperature Range		-25 to +85˚C	—
2	Capacitance		Within specified tolerance.	The capacitance shall be measured at 20˚C with 1± 0.2kHz and 0.1Vrms max. (SR: 1.0Vrms max.)
3	Dissipation Factor (D. F.)		F : D. F.=<5.0% SR: D. F.=<2.5% (16V) D. F.=<1.0% (25V)	Same condition as capacitance.
4	Insulation Resistance (I. R.)		F : 5MΩ · μF min. SR: 100MΩ min. (16V) : 1000MΩ or 20MΩ · μF min. whichever is smaller. (25V)	The insulation resistance shall be measured with 10±1V within 60±5 sec. of charging.
5	Dielectric Strength	Between lead wires	No failure.	The capacitors shall not be damage when DC voltage of 250% of the rated voltage are applied between the lead wires for 1 to 5 sec. (Charge/discharge current=<10mA)
		Body Insulation	No failure.	The capacitor is placed in the container with metal balls of diameter 1mm so that each lead wire, short-circuited, is kept approximately 2mm off the balls as shown in the figure, and DC voltage of 250% of the rated voltage is applied for 1 to 5 sec. between capacitor lead wires and small metals. (Charge/discharge current=<10mA) 
6	Temperature Characteristic	No DC voltage	F : Within $^{+30}_{-80}$% SR: Within ±15%	The capacitance measurement shall be made at each step specified in table and at a sufficient number of intermediate temperatures between step 2 and 7. Capacitance change from the value of step 3 shall not exceed the limit specified.
		With DC voltage	F : Within $^{+30}_{-95}$% SR: Within $^{+15}_{-30}$%	
7	Vibration Resistance	Appearance	No marked defect.	The capacitor shall firmly be soldered to the supporting lead wire and vibration which is 10 to 55Hz in the vibration frequency range. 1.5mm in total amplitude, and about 1 minute in the rate of vibration change from 10Hz to 55Hz and back to 10Hz is applied for a total of 6 hours; 2 hours each in 3 mutually perpendicular directions.
		Capacitance	Within specified tolerance.	
		D. F.	Satisfies initial requirement.	
8	Soldering Effect	Appearance	No marked defect.	The lead wire shall be immersed into the melted solder of 350±10˚C (Nominal body diameter ϕ4mm 270±5˚C) up to about 1.5 to 2mm from the main body for 3.5±0.5 sec. (Nominal body diameter ϕ4mm 5±0.5˚C sec.)
		Capacitance Change	F : Within±20% SR: Within± 5%	
		D. F.	Satisfies initial requirement.	
		I. R.	Satisfies initial requirement.	
		Dielectric Strength (Between lead wires)	Pass the item No. 5.	
9	Humidity (Under steady state)	Appearance	No marked defect.	Set the capacitor for 500$^{+24}_{0}$ hours at 40±2˚C in 90 to 95% humidity.
		Capacitance Change	F : Within ±20% SR: Within ±10%	
		D. F.	F : D. F.=<7.5% SR: D. F.=<4.0% (16V) D. F.=<1.5% (25V)	
		I. R.	F : Satisfies initial requirement. SR: $\frac{1}{2}$ of initial requirement or over.	
		Dielectric Strength (Between lead wires)	Pass the item No. 5.	

Step	1	2	3	4
Temp.	20±2˚C	-25±3˚C	20±2˚C	85±2˚C
DC Voltage applied	None	None	None	None

Step	5	6	7	8
Temp.	85±2˚C	20±2˚C	-25±3˚C	20±2˚C
DC Voltage applied	$\frac{1}{2}$ Rated	$\frac{1}{2}$ Rated	$\frac{1}{2}$ Rated	$\frac{1}{2}$ Rated

Pre-treatment: Capacitor shall be stored at 125±3˚C for 1 hour, then placed at *room condition for 24±2 hours before measurements.

Pre-treatment: Capacitor shall be stored at 125±3˚C for 1 hour, then placed at *room condition for 24±2 hours before measurements of capacitance and D.F.

Post-treatment: Capacitor shall be stored for 24±2 hours at *room condition.

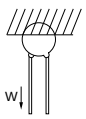
Measurement Order: I.R. · Dielectric Strength→Pre-treatment→Capacitance · D.F.→Soldering Effect test→Post-treatment→Capacitance· D.F. · I.R. · Dielectric Strength

Pre-treatment: Capacitor shall be stored at 125±3˚C for 1 hour, then placed at *room condition for 24±2 hours before measurements of capacitance and D.F.

Post-treatment: Capacitor shall be stored for 1 to 2 hours at *room condition.

Measurement Order: I.R. · Dielectric Strength→Pre-treatment→Capacitance · D.F.→Humidity test→Post-treatment→Capacitance · D.F. · I.R. · Dielectric Strength

* "room condition" temperature: 15-35˚C humidity: 45-75% atmospheric pressure: 86-106kPa

Item			Specification	Testing Method
10	Humidity Loading	Appearance	No marked defect.	Apply the rated voltage for 500^{+24}_{-0} hours at 40±2˚C in 90 to 95% humidity. Pre-treatment and Post-treatment: Capacitor shall be stored at 125±3˚C for 1 hour, then placed at *room condition for 24±2 hours, before measurements of capacitance and D. F. Measurement Order: I.R. · Dielectric Strength→Pre-treatment→ Capacitance · D.F.→Humidity Loading test→ I.R. · Dielectric Strength*→Post-treatment→ Capacitance · D.F. (Charge/discharge current=<10mA)
		Capacitance Change	F : Within ±20% SR: Within ±10%	
		D. F.	F : D. F.=<7.5% SR: D. F.=<4.0% (16V) D. F.=<1.5% (25V)	
		I. R.	F : Satisfies initial requirement. SR: $\frac{1}{2}$ of initial requirement or over.	
		Dielectric Strength (Between lead wires)	Pass the item No. 5.	
11	Life	Appearance	No marked defect.	Apply a DC voltage of 150% of the rated voltage for 1000^{+48}_{-0} hours at 85±2˚C. Pre-treatment and Post-treatment: Capacitor shall be stored at 125±3˚C for 1 hour, then placed at *room condition for 24±2 hours, before measurements of capacitance and D. F. Measurement Order: I.R. · Dielectric Strength→Pre-treatment→ Capacitance · D.F.→Life test→I.R. · Dielectric Strength*→Post-treatment→Capacitance · D.F. (Charge/discharge current=<10mA)
		Capacitance Change	F : Within ±20% SR: Within ±10%	
		D. F.	F : D. F.=<7.5% SR: D. F.=<4.0% (16V) D. F.=<1.5% (25V)	
		I. R.	F : Satisfies initial requirement. SR: $\frac{1}{2}$ of initial requirement or over.	
		Dielectric Strength (Between lead wires)	Pass the item No. 5.	
12	Temperature and immersion cycling	Appearance	No marked defect.	The capacitor shall be subjected to 5 cycles of temperature variation according to Table 1, then the capacitor shall be immersed into two baths, the one a clean water bath at temperature 65^{+5}_{-0}˚C and the other a saturated salt water bath at temperature 0±3˚C for 15 minutes. This immersion cycle shall be repeated 2 times, then the capacitor shall be washed in running water, wiped or dried with air draught. Pre-treatment: Capacitor shall be stored at 125±3˚C for 1 hour, then placed at *room condition for 24±2 hours before measurements of capacitance and D. F. Post-treatment: Capacitor shall be stored for 24±2 hours at *2room condition. Measuretment Order: I.R. · Dielectric Strength→Pre-treatment→ Capacitance · D.F.→Temperature and Immersion cycling test→Post-treatment→ Capacitance · D.F. · I.R. · Dielectric Strength (Table1)
		Capacitance Change	F : Within ±20% SR: Within ±10%	
		D. F.	F : D. F.=<7.5% SR: D. F.=<4.0% (16V) D. F.=<1.5% (25V)	
		I. R.	F : Satisfies initial requirement. SR: $\frac{1}{2}$ of initial requirement or over.	
		Dielectric Strength (Between lead wires)	Pass the item No. 5.	
13	Strength of Lead	Pull	Lead wire shall not cut off. Capacitor shall not be broken.	As a figure, fix the body of capacitor, apply a tensile weight gradually to each lead wire in the radial direction of capacitor up to 10N (1.0kgf) and keep it for 10±1 sec. 
		Bending		Each lead wire shall be subjected to 5N (0.51kgf) weight and then a 90˚ bend, at the point of egress, in one direction, return to original position, and then a 90˚ bend in the opposite direction at the rate of one bend in 2 to 3 seconds.
14	Solderability of Leads		Lead wire shall be soldered with uniformly coated on the axial direction over $\frac{3}{4}$ of the circumferential direction.	The lead wire of a capacitor shall be dipped into a methanol solution of 25wt% rosin and then into molten solder of 235±5˚C for 2±0.5 seconds. In both cases the depth of dipping is up to about 1.5 to 2.0mm from the root of lead wires.

(Table1)

Step	Temperature (˚C)	Time
1	-25^{+0}_{-3}	30 minutes
2	room temp.	3 minutes
3	85^{+3}_{-0}	30 minutes
4	room temp.	3 minutes

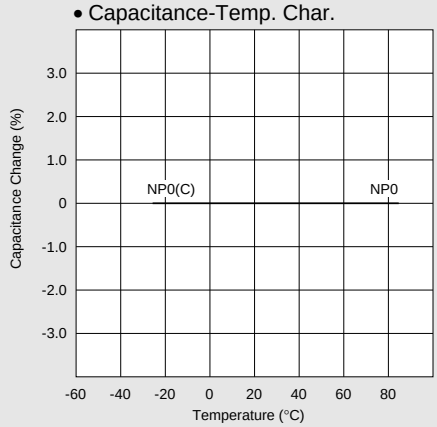
* "room condition" temperature: 15-35˚C humidity: 45-75% atmospheric pressure: 86-106kPa

* The measurement of I.R. and Dielectric Strength will be held in 1 to 2 hours after Humidity Loading test and in 24±2 hours after Life test.

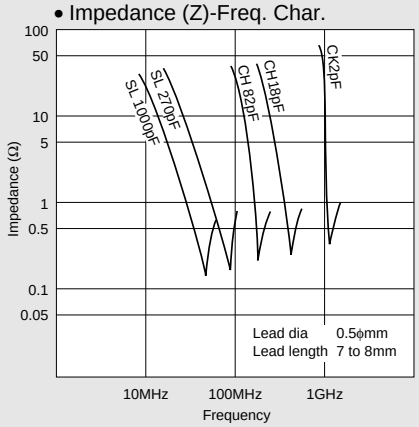
7. TYPICAL CHARACTERISTICS DATA

7.1 DD100/DD10 SERIES

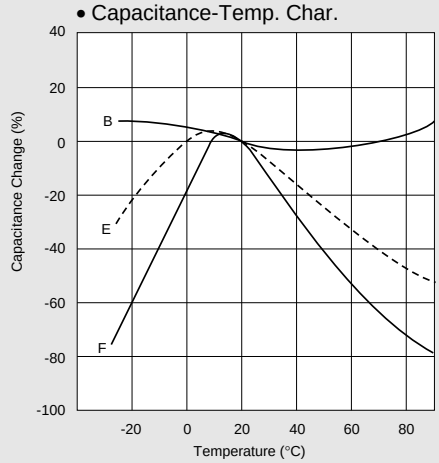
• Capacitance-Temp. Char.



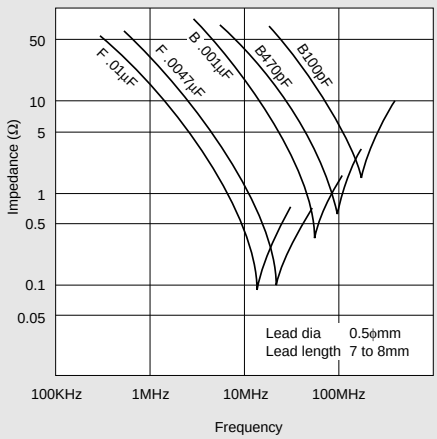
• Impedance (Z)-Freq. Char.



• Capacitance-Temp. Char.

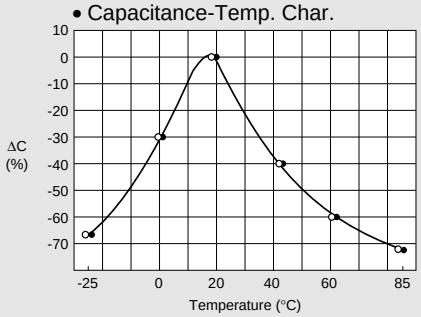


• Impedance (Z)-Freq. Char.



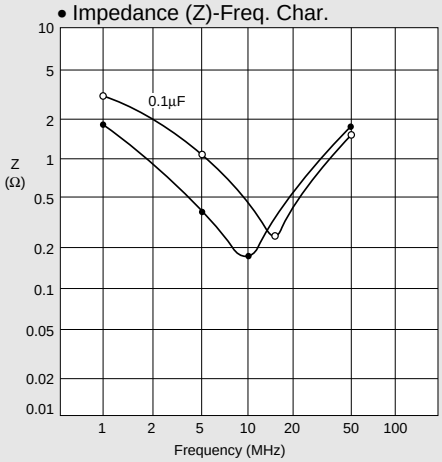
7.2 DD300/DD400 SERIES

• Capacitance-Temp. Char.

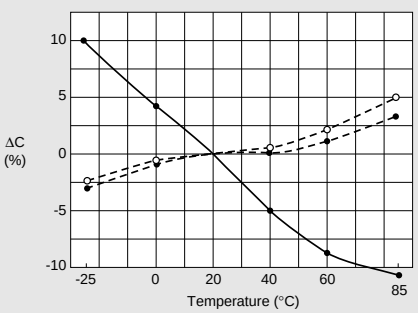


BC Capacitor DD300 Series F Char. 25V.
BC Capacitor DD300 Series F Char. 50V.

• Impedance (Z)-Freq. Char.

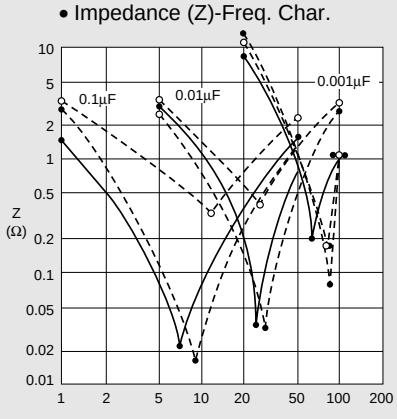


• Capacitance-Temp. Char.



BC Capacitor DD400 Series SR Char. 25V.
Polyester Film Capacitor Ceneral Type.
Polyester Film Capacitor Noninductive Type.

• Impedance (Z)-Freq. Char.



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   ③ Undersea equipment
   ④ Medical equipment
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   ⑦ Disaster prevention / crime prevention equipment
   ⑧ Data-processing equipment
   ⑨ Applications of similar complexity or with reliability requirements comparable to the applications listed in the above
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